

Supplemental Application Data Sheet

Application Information

Application number::	<u>10/763,561</u>
Filing Date::	<u>01/22/04</u>
Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	<u>N/A 2819</u>
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	DISTRIBUTED CURRENT SOURCES FOR FOLDING ADC AMPLIFIER STAGES
Attorney Docket Number::	08211/0200350-US0/P05787
Request for Early Publication?::	No
Request for Non-Publication?::	Yes
Total Drawing Sheets::	6
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Christopher
Middle Name::	Alan
Family Name::	Menkus
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Correspondence Information

Correspondence Customer Number:: 38845

Representative Information

Representative Customer Number:: 38845

Assignee Information

<u>Assignee name::</u>	<u>National Semiconductor Corporation</u>
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